



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Farnworth et al.

Serial No.: 09/923,687

Filed: August 6, 2001

For: HERMETIC CHIP SIZE AND
METHOD OF MANUFACTURE

Confirmation No.: 3349

Examiner: F. Toledo

Group Art Unit: 2823

Attorney Docket No.: 2741.5US
(95-0804.4)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

February 27, 2003
Date

Signature

Deidra Pfeil

Name (Type/Print)

RECEIVED
MAR 10 2003
TECHNOLOGY CENTER 2800

AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

Sir:

This amendment is in response to the Office Action of December 4, 2002, whose initial period of response is set to expire on March 4, 2003.